

## Quad Sine-Wave Clock Buffer With LDO

Check for Samples: [CDC3S04](#)

### FEATURES

- **1:4 Low-Jitter Clock Buffer**
- **Single-Ended Sine-Wave Clock Input and Outputs**
- **Ultralow Phase Noise and Standby Current**
- **Individual Clock Request Inputs for Each Output**
- **On-Chip Low-Dropout Output (LDO) for Low-Noise TCXO Supply**
- **Serial I<sup>2</sup>C Interface (Compatible With High-Speed Mode, 3.4 Mbit/s)**
- **1.8-V Device Power Supply**
- **Wide Temperature Range, –40°C to 85°C**
- **ESD Protection: 2 kV HBM, 750 V CDM, and 100 V MM**
- **Small 20-Pin Chip-Scale Package: 0.4-mm Pitch WCSP (1.6 mm × 2 mm)**

### APPLICATIONS

- **Cellular Phones**
- **Smart Phones**
- **Mobile Handsets**
- **Portable Systems**
- **Wireless Modems Including GPS, WLAN, W-BT, D-TV, DVB-H, FM Radio, WiMAX, and System Clock**

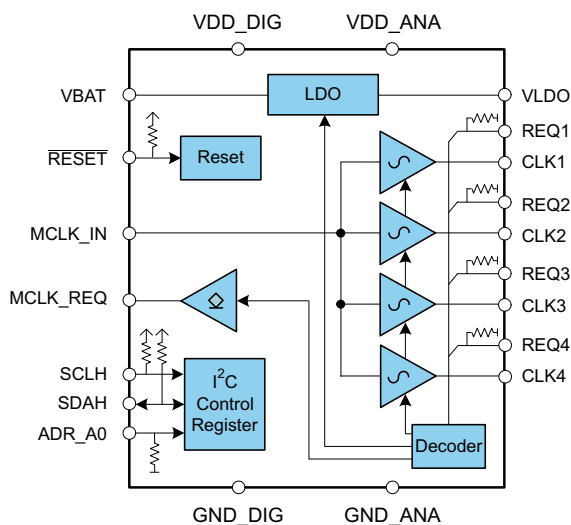
### DESCRIPTION

The CDC3S04 is a four-channel low-power low-jitter sine-wave clock buffer. It can be used to buffer a single master clock to multiple peripherals. The four sine-wave outputs (CLK1–CLK4) are designed for minimal channel-to-channel skew and ultralow additive output jitter.

Each output has its own clock request inputs which enables the dedicated clock output. These clock requests are active-high (can also be changed to be active-low via I<sup>2</sup>C), and an output signal is generated that can be sent back to the master clock to request the clock (MCLK\_REQ). MCLK\_REQ is an open-source output and supports the wired-OR function (default mode). It needs an external pulldown resistor. MCLK\_REQ can be changed to wired-AND or push-pull functionality via I<sup>2</sup>C.

The CDC3S04 also provides an I<sup>2</sup>C interface (Hs-mode) that can be used to enable or disable the outputs, select the polarity of the REQ inputs, and allow control of internal decoding.

The CDC3S04 features an on-chip high-performance LDO that accepts voltages from 2.3 V to 5.5 V and outputs a 1.8-V supply. This 1.8-V supply can be used to power an external 1.8-V TCXO. It can be enabled or disabled for power saving at the TCXO.


**WCSP**

|   | 1       | 2       | 3        | 4       |
|---|---------|---------|----------|---------|
| A | REQ2    | CLK2    | REQ1     | CLK1    |
| B | MCLK_IN | RESET   | VDD_ANA  | GND_ANA |
| C | REQ4    | CLK4    | REQ3     | CLK3    |
| D | VDD_DIG | GND_DIG | MCLK_REQ | ADR_A0  |
| E | VLDO    | VBAT    | SDAH     | SCLH    |

Top View  
(Solder Ball Underneath)



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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## DESCRIPTION (CONTINUED)

A low signal at the **RESET** input switches the outputs CLK1 and CLK4 into the default state. In this configuration, CLK1 and CLK4 are ON (see [Table 1](#)); the remaining device function is not affected. Also, the **RESET** input provides a glitch filter which rejects spikes of typical 300 ns on the **RESET** line to preserve false reset. A complete device reset to the default condition can be initiated by a power-up cycle of V<sub>DD\_DIG</sub>.

The CDC3S04 operates from two 1.8-V supplies. There is a core supply (VDD\_DIG/GND\_DIG) for the core logic and a low-noise analog supply (VDD\_ANA/GND\_ANA) for the sine-wave outputs. The CDC3S04 is designed for sequence-less power up. Both supply voltages may be applied in any order.

The CDC3S04 is offered in a 0.4-mm pitch WCSP package (1.6 mm × 2 mm) and is optimized for low standby current (0.5 µA). It is characterized for operation from –40°C to 85°C.

## DEVICE INFORMATION

### PIN FUNCTIONS

| NAME         | BALL NO. | TYPE         | FUNCTION                                                                                                                                                                                                                                           |
|--------------|----------|--------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| ADR_A0       | D4       | Input        | Selectable address bit A0 of slave-address register; internal 500-kΩ pulldown resistor                                                                                                                                                             |
| CLK1         | A4       | Output       | Clock output 1                                                                                                                                                                                                                                     |
| CLK2         | A2       | Output       | Clock output 2                                                                                                                                                                                                                                     |
| CLK3         | C4       | Output       | Clock output 3                                                                                                                                                                                                                                     |
| CLK4         | C2       | Output       | Clock output 4                                                                                                                                                                                                                                     |
| GND_ANA      | B4       | Ground       | Ground for sine-wave buffer                                                                                                                                                                                                                        |
| GND_DIG      | D2       | Ground       | Ground for core logic                                                                                                                                                                                                                              |
| MCLK_IN      | B1       | Input        | Master clock input                                                                                                                                                                                                                                 |
| MCLK_REQ     | D3       | Output       | Clock request to the master clock source; active-high; open-source output for wired-OR connection (default condition). Can be changed to push-pull output or wired-AND output via I <sup>2</sup> C.                                                |
| REQ1         | A3       | Input        | Clock request from peripheral 1; internal 500-kΩ pulldown resistor                                                                                                                                                                                 |
| REQ2         | A1       | Input        | Clock request from peripheral 2; internal 500-kΩ pulldown resistor                                                                                                                                                                                 |
| REQ3         | C3       | Input        | Clock request from peripheral 3; internal 500-kΩ pulldown resistor                                                                                                                                                                                 |
| REQ4         | C1       | Input        | Clock request from peripheral 4; internal 500-kΩ pulldown resistor                                                                                                                                                                                 |
| <b>RESET</b> | B2       | Input        | Peripheral reset signal provided by application processor. The signal is active-low and switches CLK1 and CLK4 outputs to ON (see <a href="#">Table 1</a> ). On-chip LDO is enabled. Internal 1-MΩ pullup resistor and 300-ns (typ) glitch filter. |
| SCLH         | E4       | Input        | I <sup>2</sup> C clock input – Hs-mode. Internal 1-MΩ pullup resistor                                                                                                                                                                              |
| SDAH         | E3       | Input/output | I <sup>2</sup> C data input/output – Hs-mode. Internal 1-MΩ pullup resistor                                                                                                                                                                        |
| VBAT         | E2       | Power        | Supply pin to internal LDO                                                                                                                                                                                                                         |
| VDD_ANA      | B3       | Power        | 1.8-V power supply for sine-wave buffer                                                                                                                                                                                                            |
| VDD_DIG      | D1       | Power        | 1.8-V power supply for core logic. Power up of VDD_DIG resets the whole device to the default condition.                                                                                                                                           |
| VLDO         | E1       | Output       | 1.8-V supply for external TCXO; LDO is enabled if <b>RESET</b> (default mode) or REQx is active. LDO is not enabled if only VBAT is on.                                                                                                            |

## FUNCTION SELECTION TABLES

**Table 1. Reset and Request (REQx) Conditions for Clock Outputs<sup>(1)</sup>**

| RESET <sup>(2)</sup> | PRIORITY BIT <sup>(3)</sup> | CLK1                  | CLK2                  | CLK3                  | CLK4                  |
|----------------------|-----------------------------|-----------------------|-----------------------|-----------------------|-----------------------|
| 0                    | 0                           | On                    | Controlled by REQ2    | Controlled by REQ3    | On                    |
|                      | 1                           |                       | Controlled by REQ2INT | Controlled by REQ3INT |                       |
| 1                    | 0                           | Controlled by REQ1    | Controlled by REQ2    | Controlled by REQ3    | Controlled by REQ4    |
|                      | 1                           | Controlled by REQ1INT | Controlled by REQ2INT | Controlled by REQ3INT | Controlled by REQ4INT |

- (1) Shaded cells show the default setting after power up.
- (2) RESET resets REQ1PRIO/REQ4PRIO and REQ1INT/REQ4INT bits to their default values (CLK1/4 is ON) but does not change the remaining internal SW bits. During RESET, any I<sup>2</sup>C operation is blocked until RESET is deactivated. A minimum pulse duration of 500 ns must be applied to activate RESET (the internal glitch-filter suppresses spikes of typical 300 ns).
- (3) Priority bit defines if the external control pins (HW controlled) or the SW bits (SW controlled) have priority. It can be set in the configuration register, Byte 2, Bits 0–3.

**Table 2. Request Signal Condition for Clock Outputs<sup>(1)</sup>**

| REQ-Signals <sup>(2)</sup> | REQx<br>(REQ1/2/3/4) | CLKx<br>(CLK1/2/3/4)            | MCLK_REQ                   | LDO <sup>(3)</sup>         |
|----------------------------|----------------------|---------------------------------|----------------------------|----------------------------|
| Active-low                 | 0                    | Clock                           | High                       | On                         |
|                            | 1                    | Disabled to high                | Low (if all REQx are high) | Off (if all REQx are high) |
| Active-high                | 0                    | Disabled to high <sup>(4)</sup> | Low (if all REQx are low)  | Off (if all REQx are low)  |
|                            | 1                    | Clock <sup>(4)</sup>            | High                       | On                         |

- (1) Shaded cells show the default setting after power up.
- (2) Polarity of REQ1, REQ2, REQ3, and REQ4 are register-configurable via I<sup>2</sup>C (see Table 3, Byte 0, Bits 0–3). Default setting is active-high.
- (3) The LDO is controlled by an on-chip decoder, but can also be SW controlled (see Table 3, Byte 2, Bits 4–5).
- (4) CLK1 and CLK4 are ON after device power up (default condition). CLK2 and CLK3 are controlled by external REQ2 and REQ3, respectively.

## POWER GROUPS

| NAME    | DESCRIPTION                                                                                                                                                                                                                                                          |
|---------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| VBAT    | Supply pin for LDO provided by main battery. LDO is not working if only VBAT is on.                                                                                                                                                                                  |
| VLDO    | 1.8-V low-drop output voltage for external TCXO. LDO is enabled if VBAT and VDD_DIG are on and REQx or RESET is active (see Table 2).                                                                                                                                |
| VDD_DIG | 1.8-V power supply for core logic and I <sup>2</sup> C logic. VDD_DIG must be supplied for correct device operation. Power up of VDD_DIG resets the whole device to the default condition.                                                                           |
| VDD_ANA | 1.8-V power supply for sine-wave buffers. For correct sine-wave buffer function, all three power supplies (VBAT, VDD_DIG and VDD_ANA) must be on. But, VDD_ANA can be switched on and off at any time. If off, the sine-wave outputs are switched to high-impedance. |

## POWER-UP SEQUENCE

The CDC3S04 is designed for sequence-less power up. VBAT, V<sub>DD\_DIG</sub>, and V<sub>DD\_ANA</sub> may be applied in any order. Recommended power-on sequence is VBAT first, followed by V<sub>DD\_DIG</sub> and V<sub>DD\_ANA</sub>. Recommended power-off sequence is in reverse order.

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## ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted) <sup>(1)</sup>

|                                            |                                                                       | VALUE                          | UNIT |
|--------------------------------------------|-----------------------------------------------------------------------|--------------------------------|------|
| V <sub>DD_ANA</sub><br>V <sub>DD_DIG</sub> | Supply voltage range                                                  | –0.5 to 2.5                    | V    |
| V <sub>BAT</sub>                           | Battery supply voltage range                                          | –0.5 to 6.5                    | V    |
| V <sub>I</sub>                             | Input voltage range <sup>(2)</sup> <sup>(3)</sup>                     | –0.5 to V <sub>DD</sub> + 0.5  | V    |
| V <sub>O</sub>                             | Output voltage range <sup>(2)</sup> <sup>(3)</sup>                    | –0.5 to V <sub>DD</sub> + 0.5  | V    |
| V <sub>LDO</sub>                           | Output voltage range                                                  | –0.5 to V <sub>BAT</sub> + 0.5 | V    |
|                                            | Input current (V <sub>I</sub> < 0, V <sub>I</sub> > V <sub>DD</sub> ) | ±20                            | mA   |
| I <sub>O</sub>                             | Continuous output current                                             | ±20                            | mA   |
| I <sub>LDO</sub>                           | Continuous output current                                             | ±20                            | mA   |
| T <sub>stg</sub>                           | Storage temperature range                                             | –65 to 150                     | °C   |

- (1) Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input and output negative voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- (3) The input V<sub>I</sub> and output V<sub>O</sub> positive voltages are limited to the absolute maximum rating for V<sub>DD</sub> = 2.5 V.

## THERMAL CHARACTERISTICS for 20-pin WCSP (YFF) <sup>(1)</sup>

|                 | PARAMETER                               | AIRFLOW<br>(lfm) | 20-PIN<br>WCSP | UNIT |
|-----------------|-----------------------------------------|------------------|----------------|------|
| T <sub>JA</sub> | Thermal resistance, junction-to-ambient | 0                | 71             | °C/W |
|                 |                                         | 200              | 62             |      |
|                 |                                         | 400              | 59             |      |
| T <sub>JC</sub> | Thermal resistance, junction-to- case   | –                | 17.5           | °C/W |
| T <sub>JB</sub> | Thermal resistance, junction-to-board   | –                | 20.5           | °C/W |
| T <sub>J</sub>  | Maximum junction temperature            | –                | 125            | °C   |

- (1) The package thermal impedance is calculated in accordance with JESD 51 and JEDEC2S2P (high-k board).

## RECOMMENDED OPERATING CONDITIONS

|                     |                                                              | MIN                      | NOM | MAX  | UNIT            |
|---------------------|--------------------------------------------------------------|--------------------------|-----|------|-----------------|
| V <sub>DD_ANA</sub> | Device supply voltage                                        | 1.65                     | 1.8 | 1.95 | V               |
| V <sub>DD_DIG</sub> | Device supply voltage                                        | 1.65                     | 1.8 | 1.95 | V               |
| V <sub>IH</sub>     | Input voltage ADR_A0, REQx, $\overline{\text{RESET}}$        | 0.65 V <sub>DD_DIG</sub> |     |      | V               |
| V <sub>IL</sub>     |                                                              | 0.35 V <sub>DD_DIG</sub> |     |      | V               |
| V <sub>IS</sub>     | Sine-wave input voltage – MCLK_IN; ac-coupled amplitude      | 0.5                      |     | 1.2  | V <sub>PP</sub> |
| C <sub>L</sub>      | Sine-wave output load <sup>(1)</sup>                         |                          | 10  | 30   | pF              |
| C <sub>OUT</sub>    | LDO output capacitance (stabilize the internal control loop) | 0.8                      | 2.2 |      | μF              |
| T <sub>A</sub>      | Operating free-air temperature                               | –40                      |     | 85   | °C              |

- (1) 10 pF is the typical load-driving capability. The drive capability can be optimized for 30 pF by the I<sup>2</sup>C register (Byte 3, Bits 7–4).

## ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER                     |                                                                          | TEST CONDITIONS                                                                                                                                                                                                                                 |              | MIN                        | TYP                     | MAX                     | UNIT |
|-------------------------------|--------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------|----------------------------|-------------------------|-------------------------|------|
| OVERALL PARAMETER             |                                                                          |                                                                                                                                                                                                                                                 |              |                            |                         |                         |      |
| I <sub>DD_ANA</sub>           | Analog supply current <sup>(1)</sup><br>(see Figure 8 through Figure 12) | V <sub>BAT</sub> = 5.5 V;<br>V <sub>DD_ANA</sub> = 1.95 V;<br>LDO is on; V <sub>IS</sub> = 1 V <sub>PP</sub> ;<br>f <sub>MCLK_IN</sub> = 38.4 MHz;<br>R <sub>L</sub> = 10 kΩ; C <sub>L</sub> = 10 pF <sup>(2)</sup>                             | Off (no REQ) |                            | 0.1                     | 0.2                     | mA   |
|                               |                                                                          |                                                                                                                                                                                                                                                 | Per output   |                            | 2                       | 2.6                     |      |
| I <sub>DD_DIG</sub>           | Digital supply current<br>(see Figure 8 through Figure 12)               | V <sub>BAT</sub> = 5.5 V; V <sub>DD_DIG</sub> = 1.95 V; V <sub>DD_ANA</sub> = off;<br>LDO = off; V <sub>IS</sub> = 1 V <sub>pp</sub> ; f <sub>MCLK_IN</sub> = 38.4 MHz;<br>C <sub>L</sub> = 10 pF; R <sub>L</sub> = 10 kΩ                       |              |                            |                         | 0.1                     | mA   |
| I <sub>SB</sub>               | Standby current                                                          | V <sub>BAT</sub> = 5.5 V; V <sub>DD_DIG</sub> /V <sub>DD_ANA</sub> = 1.95 V;<br>All outputs disabled (no input clock; LDO off; no REQ; RESET is inactive; I <sup>2</sup> C is in idle mode); includes 1-MΩ pullup at I <sup>2</sup> C and RESET |              |                            | 0.5                     | 10                      | μA   |
| f <sub>MCLK_IN</sub>          | Input frequency                                                          | Sine wave                                                                                                                                                                                                                                       |              | 0.01                       | 38.4                    | 52                      | MHz  |
| V <sub>OH</sub>               | MCLK_REQ high-level output voltage                                       | Wired-OR output;<br>I <sub>OH</sub> = −2 mA; V <sub>DD_DIG</sub> = 1.65 V (See Figure 3.)                                                                                                                                                       |              | V <sub>DD_DIG</sub> − 0.45 |                         |                         | V    |
|                               |                                                                          | Push-pull output; V <sub>DD_DIG</sub> = 1.65 V, I <sub>OH</sub> = −2 mA                                                                                                                                                                         |              | V <sub>DD_DIG</sub> − 0.45 |                         |                         |      |
| V <sub>OL</sub>               | MCLK_REQ low-level output voltage                                        | Wired-AND output; I <sub>OL</sub> = 2 mA<br>V <sub>DD_DIG</sub> = 1.65 V                                                                                                                                                                        |              | 0.45                       |                         |                         | V    |
|                               |                                                                          | Push-pull output; V <sub>DD_DIG</sub> = 1.65 V, I <sub>OL</sub> = 2 mA                                                                                                                                                                          |              | 0.45                       |                         |                         |      |
| V <sub>IK</sub>               | LVC MOS input voltage                                                    | V <sub>DD_DIG</sub> = 1.65 V; I <sub>I</sub> = −18 mA                                                                                                                                                                                           |              |                            |                         | −1.2                    | V    |
| I <sub>IH</sub>               | Input current ADR_A0, REQx (500-kΩ pulldown)                             | V <sub>I</sub> = V <sub>DD_DIG</sub> ; V <sub>DD_DIG</sub> = 1.95 V                                                                                                                                                                             |              |                            |                         | 6                       | μA   |
|                               | Input current RESET (1-MΩ pullup)                                        |                                                                                                                                                                                                                                                 |              |                            |                         | 2                       |      |
| I <sub>IL</sub>               | Input current ADR_A0, REQx (500-kΩ pulldown)                             | V <sub>I</sub> = 0 V; V <sub>DD_DIG</sub> = 1.95 V                                                                                                                                                                                              |              |                            |                         | −2                      | μA   |
|                               | Input current RESET (1-MΩ pullup)                                        |                                                                                                                                                                                                                                                 |              |                            |                         | −3                      |      |
| C <sub>I</sub>                | Input capacitance ADR_A0, REQx, RESET                                    | V <sub>I</sub> = 0 V or V <sub>DD_DIG</sub>                                                                                                                                                                                                     |              |                            | 3                       |                         | pF   |
| SDAH/SCLH PARAMETER (Hs-Mode) |                                                                          |                                                                                                                                                                                                                                                 |              |                            |                         |                         |      |
| V <sub>IK</sub>               | SCLH/SDAH input clamp voltage                                            | V <sub>DD_DIG</sub> = 1.65 V; I <sub>I</sub> = −18 mA                                                                                                                                                                                           |              |                            |                         | −1.2                    | V    |
| I <sub>I</sub>                | SCLH/SDAH input current                                                  | 0.1 V <sub>DD_DIG</sub> < V <sub>I</sub> < 0.9 V <sub>DD_DIG</sub>                                                                                                                                                                              |              |                            |                         | 10                      | μA   |
| V <sub>IH</sub>               | SDA/SCL input high voltage                                               |                                                                                                                                                                                                                                                 |              |                            | 0.7 V <sub>DD_DIG</sub> |                         | V    |
| V <sub>IL</sub>               | SDAH/SCLH input low voltage                                              |                                                                                                                                                                                                                                                 |              |                            |                         | 0.3 V <sub>DD_DIG</sub> | V    |
| V <sub>hys</sub>              | Hysteresis of Schmitt-trigger inputs                                     |                                                                                                                                                                                                                                                 |              |                            | 0.1 V <sub>DD_DIG</sub> |                         | V    |
| V <sub>OL</sub>               | SDAH low-level output voltage                                            | I <sub>OL</sub> = 3 mA, V <sub>DD_DIG</sub> = 1.65 V                                                                                                                                                                                            |              |                            |                         | 0.2 V <sub>DD_DIG</sub> | V    |
| C <sub>I</sub>                | SCLH input capacitance                                                   | V <sub>I</sub> = 0 V or V <sub>I</sub> = V <sub>DD_DIG</sub> <sup>(3)</sup>                                                                                                                                                                     |              |                            | 3                       | 5                       | pF   |
|                               | SDAH input capacitance                                                   | V <sub>I</sub> = 0 V or V <sub>I</sub> = V <sub>DD_DIG</sub> <sup>(3)</sup>                                                                                                                                                                     |              |                            | 8                       | 10                      |      |

(1) The total current consumption when no output is active is calculated by  $I_{DD\_ANA}(\text{off}) + I_{DD\_DIG}$ .

(2) For  $C_L = 30\text{ pF}$ , the typical current for one output is 2.2 mA (see Figure 8).

(3) The  $I^2C$  standard specifies a maximum  $C_I$  of 10 pF.

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## ELECTRICAL CHARACTERISTICS (continued)

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER                                                                          |                                                                                  | TEST CONDITIONS                                                                                                                                                               |                                             | MIN  | TYP  | MAX  | UNIT              |
|------------------------------------------------------------------------------------|----------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------|------|------|------|-------------------|
| SINE-WAVE PARAMETER (MCLK_IN is sine-wave signal, C <sub>L</sub> = 10 pF)          |                                                                                  |                                                                                                                                                                               |                                             |      |      |      |                   |
| f <sub>OUT</sub>                                                                   | Output frequency                                                                 |                                                                                                                                                                               |                                             |      |      | 52   | MHz               |
| V <sub>OS</sub>                                                                    | Output gain level (see <a href="#">Figure 17</a> )                               | MCLK_IN-to-CLKx; 10 kΩ, 10 pF; ac-coupled; f <sub>MCLK_IN</sub> > 1 MHz                                                                                                       | 0.5 ≤ V <sub>IS</sub> ≤ 1.2 V <sub>PP</sub> | −1   | −0.3 | 0    | dB                |
|                                                                                    | Output voltage                                                                   |                                                                                                                                                                               | V <sub>IS</sub> = 0.5 V <sub>PP</sub>       | 445  | 490  | 500  | mV <sub>PP</sub>  |
| t <sub>jitteradd(rms)</sub>                                                        | Additive rms jitter <sup>(4)</sup>                                               | 10 Hz to 10 MHz; f <sub>OUT</sub> = 38.4 MHz                                                                                                                                  |                                             |      | 0.3  | 0.6  | pSRMS             |
|                                                                                    |                                                                                  | 10 kHz to 10 MHz; f <sub>OUT</sub> = 38.4 MHz                                                                                                                                 |                                             |      | 0.1  | 0.2  |                   |
| p <sub>n</sub> <sub>add</sub>                                                      | Additive phase noise at f <sub>OUT</sub> = 38.4 MHz <sup>(5)</sup>               | At offset = 1 kHz                                                                                                                                                             |                                             |      | −142 | −135 | dBc/Hz            |
|                                                                                    |                                                                                  | At offset = 10 kHz                                                                                                                                                            |                                             |      | −152 | −145 |                   |
|                                                                                    |                                                                                  | At offset = 100 kHz                                                                                                                                                           |                                             |      | −157 | −150 |                   |
| R <sub>IN</sub>                                                                    | Input resistance                                                                 | At dc level                                                                                                                                                                   |                                             | 12   | 15   |      | kΩ                |
| C <sub>IN</sub>                                                                    | Input capacitance                                                                | f <sub>MCLK_IN</sub> = 38.4 MHz                                                                                                                                               |                                             |      | 5    | 7    | pF                |
| ELECTRICAL CHARACTERISTIC of LDO (C <sub>OUT</sub> = 0.8 to 2.7 μF) <sup>(6)</sup> |                                                                                  |                                                                                                                                                                               |                                             |      |      |      |                   |
| V <sub>BAT</sub>                                                                   | Input voltage range                                                              |                                                                                                                                                                               |                                             | 2.3  |      | 5.5  | V                 |
| V <sub>LDO</sub>                                                                   | LDO output voltage <sup>(7)</sup>                                                | 2.3 V < V <sub>BAT</sub> < 5.5 V, I <sub>LOAD</sub> = 5 mA                                                                                                                    |                                             | 1.72 | 1.8  | 1.9  | V                 |
| ΔV <sub>LDO</sub>                                                                  | Maximum line regulation                                                          | 2.3 V < V <sub>BAT</sub> ≤ 5.5 V, I <sub>LOAD</sub> = 5 mA                                                                                                                    |                                             |      | 0.5% |      |                   |
|                                                                                    | Maximum load regulation                                                          | 0 < I <sub>LOAD</sub> < 5 mA, V <sub>BAT</sub> = 2.3 V or 5.5 V; T <sub>J</sub> = 25°C                                                                                        |                                             |      | 0.5% |      |                   |
| I <sub>LOAD</sub>                                                                  | Load current                                                                     | C <sub>OUT</sub> = 0.8 μF to 2.7 μF                                                                                                                                           |                                             | 0    | 5    |      | mA                |
| I <sub>LCL</sub>                                                                   | LDO output current limit                                                         | V <sub>LDO</sub> = 0.9 × V <sub>LDO(TYP)</sub>                                                                                                                                |                                             | 10   |      | 60   | mA                |
| I <sub>LGND</sub>                                                                  | LDO ground pin current <sup>(8)</sup>                                            | V <sub>BAT</sub> = 3.6 V; 0 < I <sub>LOAD</sub> < 5 mA                                                                                                                        |                                             |      | 50   | 150  | μA                |
| I <sub>LSHDN</sub>                                                                 | LDO shutdown current                                                             | 2.3 V < V <sub>BAT</sub> < 5.5 V                                                                                                                                              |                                             |      |      | 0.2  | μA                |
| PSRR                                                                               | Power-supply rejection ratio (ripple rejection) (see <a href="#">Figure 20</a> ) | V <sub>BAT</sub> = 2.3 V (for min)<br>V <sub>BAT</sub> = 2.5 V (for typ)<br>V <sub>LDO</sub> = 1.8 V<br>I <sub>LOAD</sub> = 5 mA<br>V <sub>ripple</sub> = 0.1 V <sub>pp</sub> | 100 Hz                                      | 60   | 68   |      | dB                |
|                                                                                    |                                                                                  |                                                                                                                                                                               | 1 kHz                                       | 55   | 62   |      |                   |
|                                                                                    |                                                                                  |                                                                                                                                                                               | 10 kHz                                      | 45   | 52   |      |                   |
|                                                                                    |                                                                                  |                                                                                                                                                                               | 100 kHz                                     | 33   | 40   |      |                   |
|                                                                                    |                                                                                  |                                                                                                                                                                               | 1 MHz                                       | 37   | 46   |      |                   |
|                                                                                    |                                                                                  |                                                                                                                                                                               | 10 MHz                                      | 60   | 67   |      |                   |
| V <sub>N</sub>                                                                     | Output noise voltage (see <a href="#">Figure 21</a> )                            | BW = 10 Hz to 100 kHz; V <sub>LDO</sub> = 1.8 V; I <sub>LOAD</sub> = 5 mA                                                                                                     |                                             |      |      | 30   | μV <sub>RMS</sub> |

(4) Additive rms jitter is the integrated rms jitter that the device adds to the signal chain. It is calculated by

$$t_{jitadd(rms)} = \sqrt{(t_{jitout(rms)})^2 - (t_{jitin(rms)})^2}$$

. Specified with the supply ripple noise of 30 μV(rms) from 10 Hz to 100 kHz.

(5) Additive phase noise is the amount of phase noise that the device adds to the signal chain. It is calculated by

$$L_{add} (dB) = 10 \log (10^{0.1 L_{out}} - 10^{0.1 L_{in}})$$

(6) Minimum C<sub>OUT</sub> should be 100 nF to allow for stable LDO operation.

(7) LDO output voltage includes maximum line and load regulation.

(8) LDO ground pin current does not change over V<sub>BAT</sub>.

## TIMING REQUIREMENTS

over operating free-air temperature range (unless otherwise noted)  $V_{LDO} = 1.8\text{ V}$ ;  $C_L = 10\text{ pF}$ ;  $R_L = 10\text{ k}\Omega$

| PARAMETER                |                                                                                               | TEST CONDITIONS                                                                                                                                                                  | MIN | TYP <sup>(1)</sup> | MAX | UNIT          |
|--------------------------|-----------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|--------------------|-----|---------------|
| TIMING PARAMETER         |                                                                                               |                                                                                                                                                                                  |     |                    |     |               |
| $t_{PD}$                 | Propagation delay time                                                                        | MCLK_IN-to-CLKx; $f_{MCLK\_IN} = 38.4\text{ MHz}$                                                                                                                                |     |                    | 3   | ns            |
| $t_{LH}$                 | Propagation delay time, low-to-high                                                           | REQx-to-MCLK_REQ (wired-OR, $C_L = 15\text{ pF}$ , $R_L = 10\text{ k}\Omega$ );                                                                                                  |     |                    | 15  | ns            |
| $t_{CLK}$ <sup>(2)</sup> | CLKx on-time – REQ-to-CLKx                                                                    | $f_{MCLK\_IN} = 38.4\text{ MHz}$ ; $V_{DD\_ANA}$ is on;<br>$V_{IS} = 1\text{ V}$ ; $V_{OS} = -1\text{ dB}$ (see <a href="#">Figure 5</a> and <a href="#">Figure 6</a> )          |     | 0.3                | 0.4 | $\mu\text{s}$ |
|                          | CLKx on-time – RESET-to-CLKx <sup>(3)</sup>                                                   |                                                                                                                                                                                  |     | 0.6                | 0.8 | $\mu\text{s}$ |
|                          | CLKx off-time – REQ-to-CLKx                                                                   |                                                                                                                                                                                  |     |                    | 25  | ns            |
|                          | CLKx on-time – $V_{DD\_ANA}$ to-CLKx                                                          | $f_{MCLK\_IN} = 38.4\text{ MHz}$ ; $V_{IS} = 1\text{ V}$ ;<br>$V_{OS} = -1\text{ dB}$ ; measurement starts when<br>$V_{DD\_ANA}$ is 90% of 1.7 V (see <a href="#">Figure 7</a> ) |     | 20                 | 50  | $\mu\text{s}$ |
| $t_{SP}$                 | Pulse duration of spikes that must be suppressed by the input filter for RESET <sup>(3)</sup> |                                                                                                                                                                                  |     |                    | 100 | ns            |
| $t_{sk(0)}$              | Output skew <sup>(4)</sup>                                                                    | $f_{MCLK\_IN} = 38.4\text{ MHz}$ ; CLK1-to-CLK4                                                                                                                                  |     | 25                 | 50  | ps            |
| $t_{LDO}$                | LDO on-time <sup>(5)</sup><br>– REQ-to-LDO;<br>– RESET-to-LDO                                 | $V_{LDO} = 1.7\text{ V}$ , $I_{LDO} = 5\text{ mA}$ ,<br>$2.3\text{ V} < V_{BAT} < 5.5\text{ V}$ ; $C_{OUT} = 2.7\text{ }\mu\text{F}$                                             |     | 100                | 300 | $\mu\text{s}$ |

(1) All typical values are at nominal  $V_{DD\_ANA}$  and  $V_{DD\_DIG}$ .

(2) CLK on-time is measured with valid input signal ( $V_{IS} = 1\text{ Vpp}$ ). In case a TXCO is used, the LDO and TCXO are already on.

(3) Pulses above 500 ns are interpreted as a valid reset signal. Total time from RESET-to-CLKx is the sum of  $t_{SP} + t_{CLK\_RESET}$ .

(4) Output skew is calculated as the greater of the difference between the fastest and the slowest  $t_{PLH}$  or the difference between the fastest and the slowest  $t_{PHL}$ .

(5) LDO off-time depends on the discharge time of the R-C components (see [Figure 4](#)).

| PARAMETER                                                                                                                                              |                                                                                        | MIN              | MAX | UNIT |
|--------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------|------------------|-----|------|
| SDAH/SCLH TIMING REQUIREMENTS, Hs-Mode ( $C_{BUS} = 100\text{ pF}$ for each $I^2C$ line; see <a href="#">Figure 24</a> and <a href="#">Figure 25</a> ) |                                                                                        |                  |     |      |
| $f_{SCLH}$                                                                                                                                             | SCLH clock frequency                                                                   | 0                | 3.4 | MHz  |
| $t_{su(START)}$                                                                                                                                        | START setup time (SCLH high before SDAH low)                                           | 160              |     | ns   |
| $t_{h(START)}$                                                                                                                                         | START hold time (SCLH low after SDAH low)                                              | 160              |     | ns   |
| $t_{LOW}$                                                                                                                                              | Low period of the SCLH clock                                                           | 160              |     | ns   |
| $t_{HIGH}$                                                                                                                                             | High period of the SCLH clock                                                          | 60               |     | ns   |
| $t_{h(SDAH)}$                                                                                                                                          | SDAH hold time (SDAH valid after SCLH low)                                             | 0 <sup>(1)</sup> | 70  | ns   |
| $t_{su(SDAH)}$                                                                                                                                         | SDAH setup time                                                                        | 10               |     | ns   |
| $t_r$                                                                                                                                                  | SCLH rise time                                                                         | 10               | 40  | ns   |
|                                                                                                                                                        | SDAH rise time                                                                         | 10               | 80  |      |
| $t_f$                                                                                                                                                  | SCLH fall time                                                                         | 10               | 40  | ns   |
|                                                                                                                                                        | SDAH fall time                                                                         | 10               | 80  |      |
| $t_{su(STOP)}$                                                                                                                                         | STOP setup time                                                                        | 160              |     | ns   |
| $t_{SP}$                                                                                                                                               | Pulse duration of spikes that must be suppressed by the input filter for SDAH and SCLH | 0                | 10  | ns   |

(1) A device must internally provide a data hold time to bridge the undefined period between  $V_{IH}$  and  $V_{IL}$  of the falling edge of the SCLH signal. An input circuit with a threshold as low as possible for the falling edge of the SCLH signal minimizes this hold time.

## PARAMETER MEASUREMENT INFORMATION

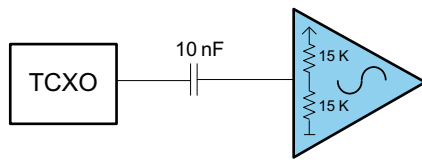


Figure 1. Input Circuit

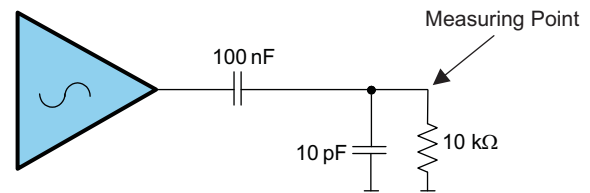


Figure 2. Output Circuit

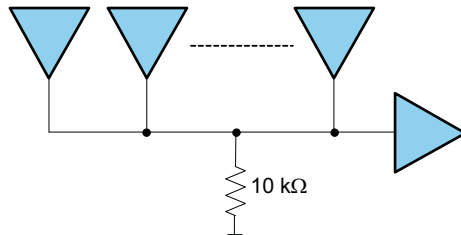
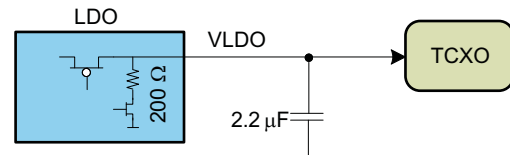


Figure 3. Wired OR



i.e. time constant( $R \times C$ ) is  $440 \mu s$  for 63% discharge.

Figure 4. LDO Output Circuit

## TYPICAL CHARACTERISTICS

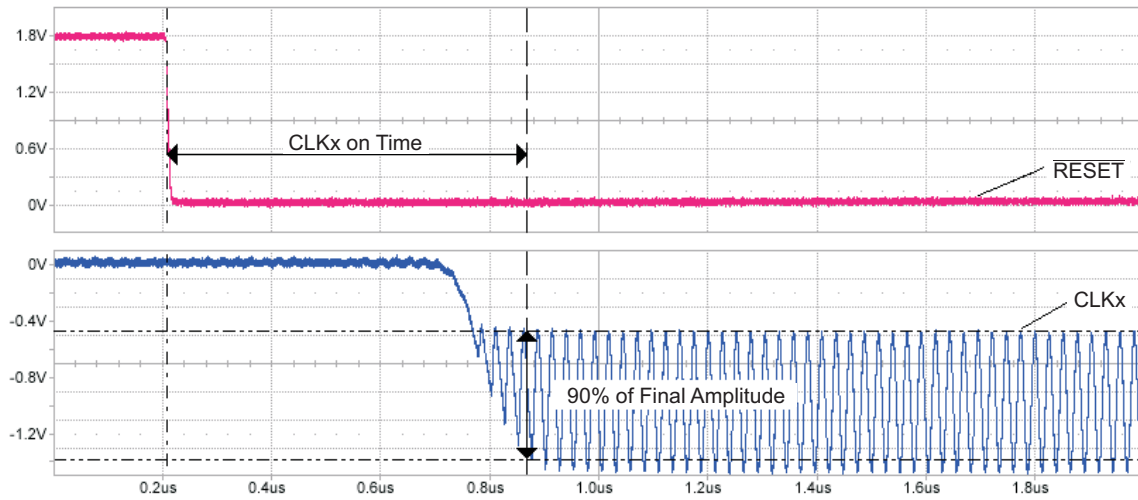


Figure 5. CLKx On-Time From  $\overline{\text{RESET}}$  Off-to-On

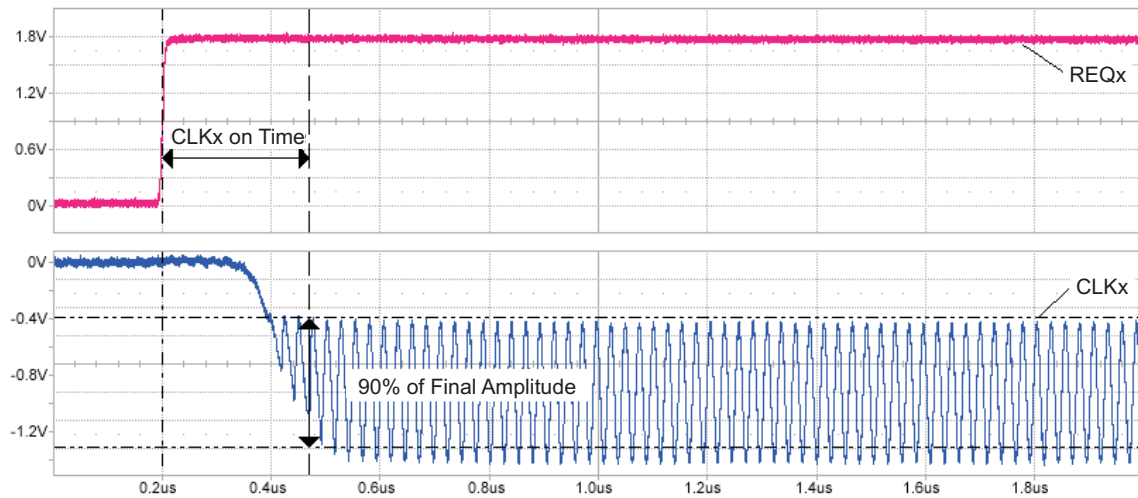


Figure 6. CLKx On-Time From REQ Off-to-On

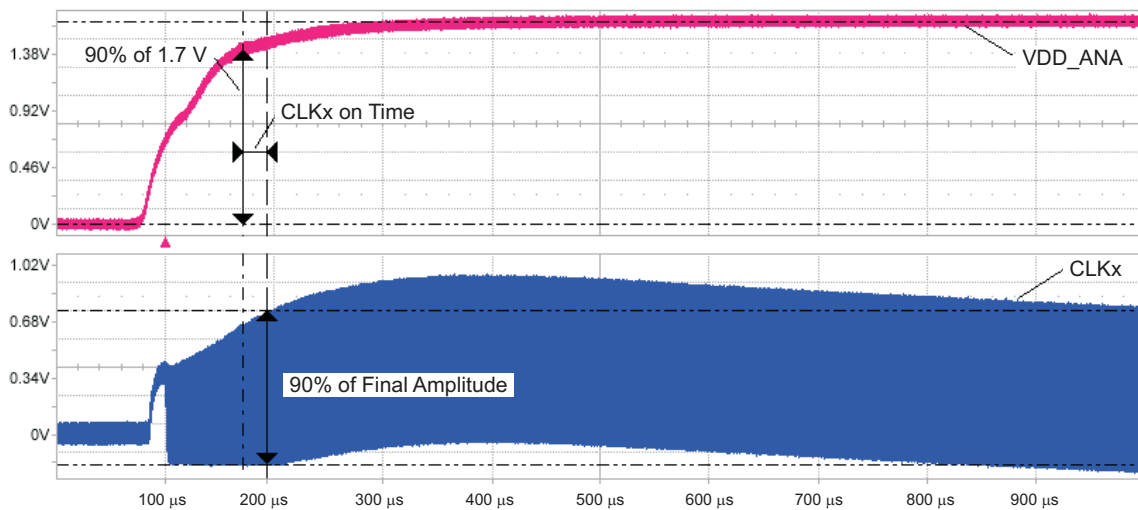


Figure 7. CLKx On-Time From  $V_{\text{DD\_ANA}}$  Off-to-On

## TYPICAL CHARACTERISTICS (continued)

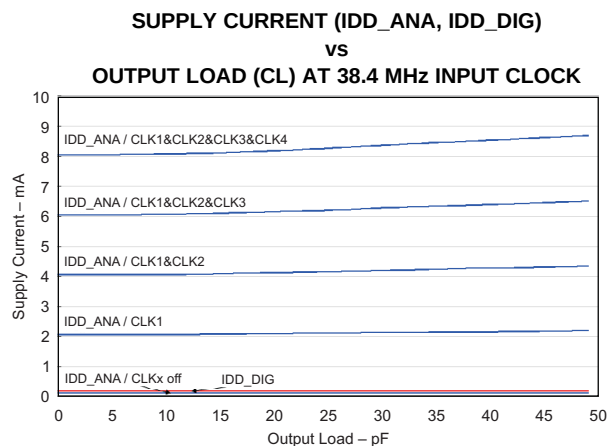


Figure 8.

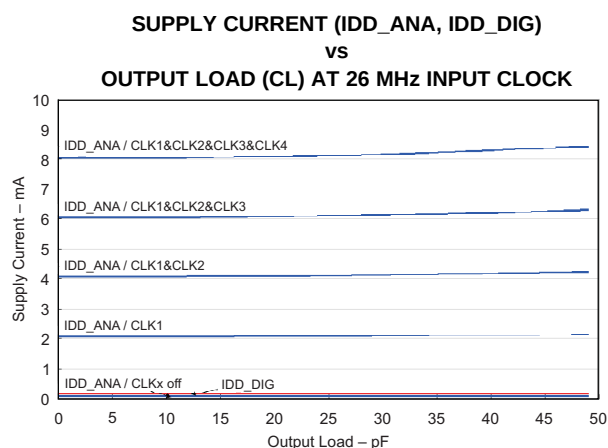


Figure 9.

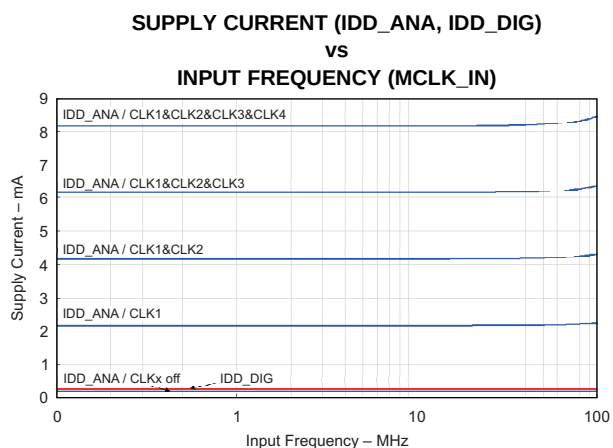
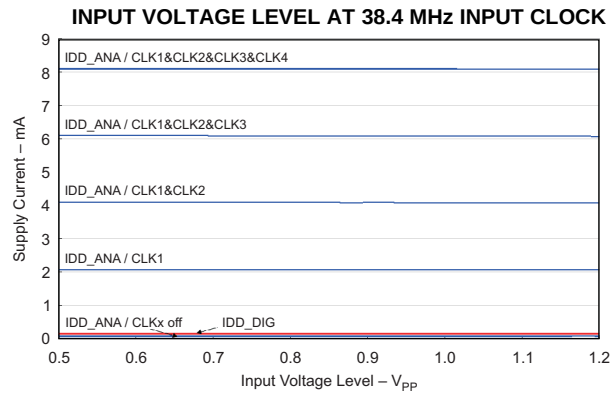
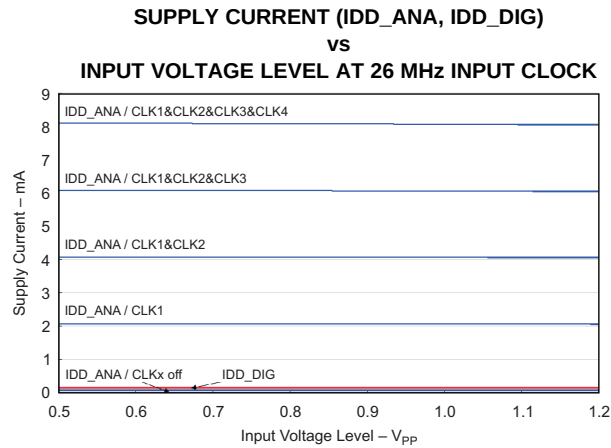


Figure 10.

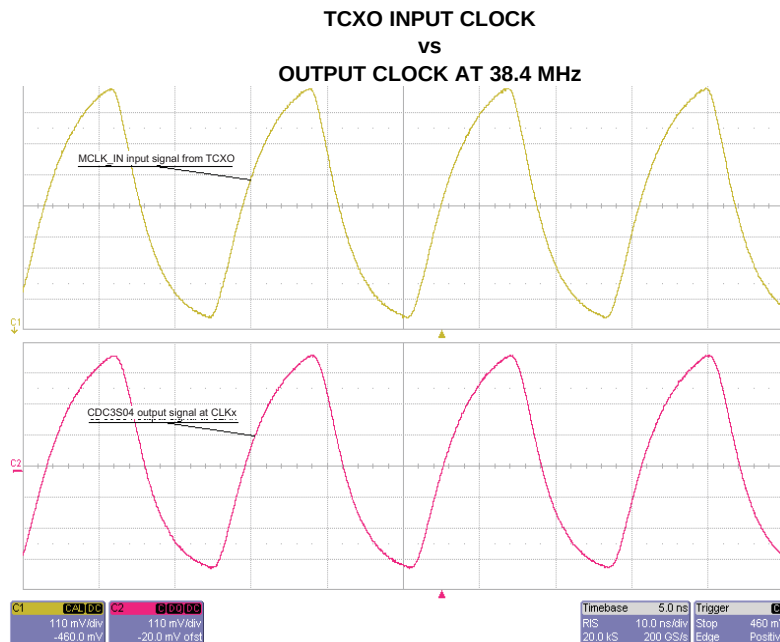
**TYPICAL CHARACTERISTICS (continued)**  
**SUPPLY CURRENT (IDD\_ANA, IDD\_DIG)**  
**vs**



**Figure 11.**



**Figure 12.**



**Figure 13.**

## TYPICAL CHARACTERISTICS (continued)

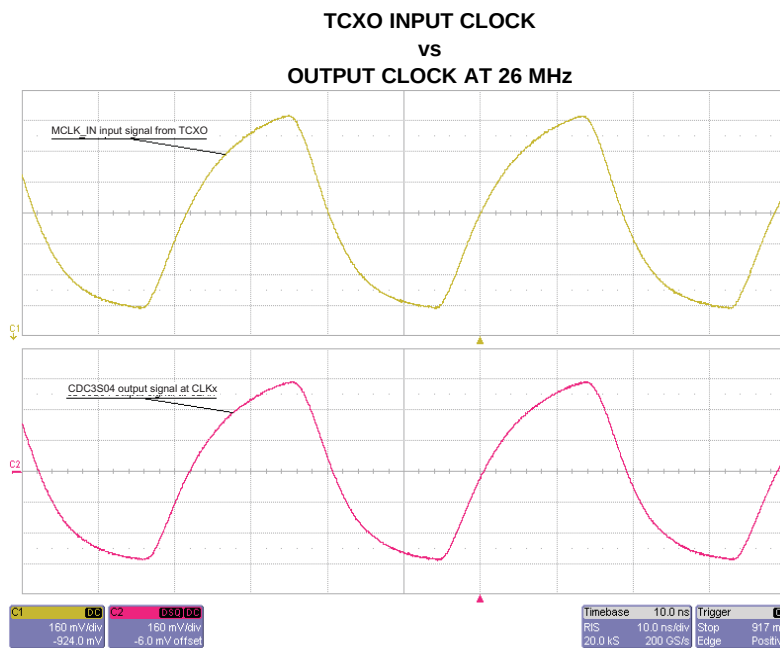


Figure 14.

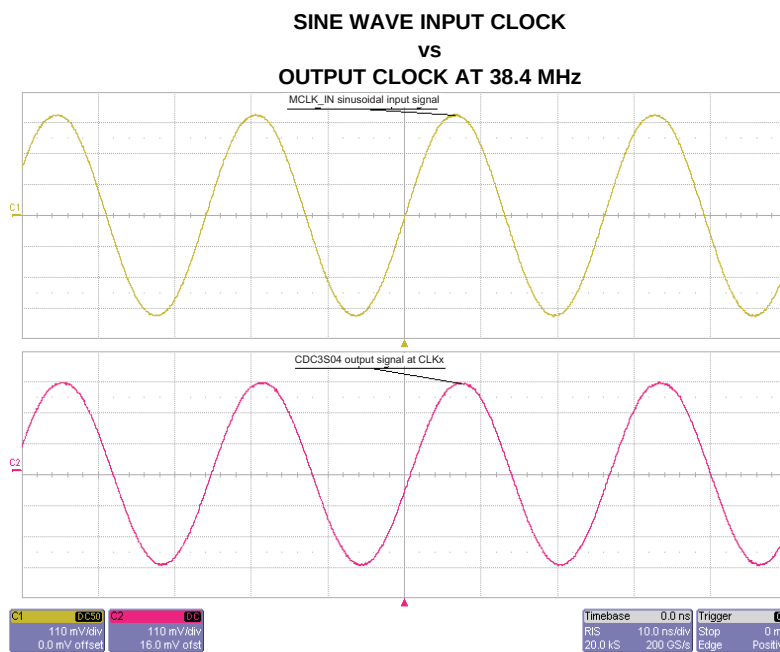


Figure 15.

## TYPICAL CHARACTERISTICS (continued)

SINE WAVE INPUT CLOCK

vs

OUTPUT CLOCK AT 26 MHz

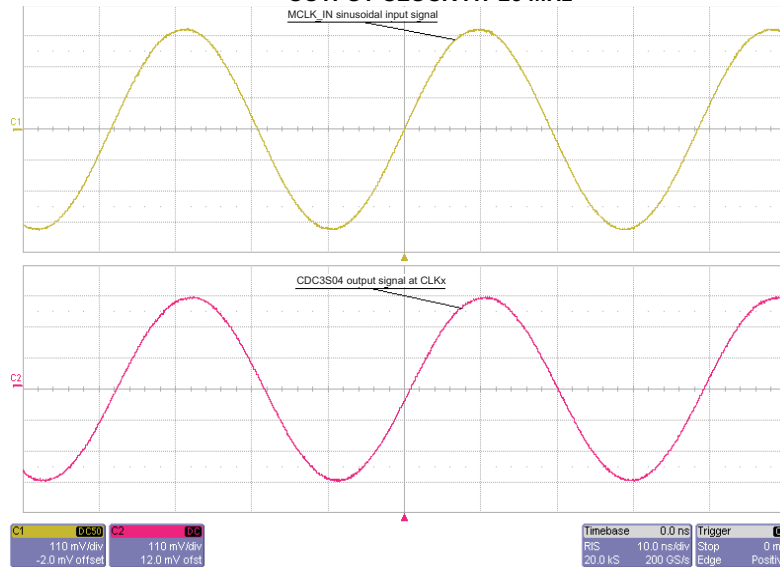


Figure 16.

OUTPUT GAIN

vs

INPUT FREQUENCY (MCLK\_IN)

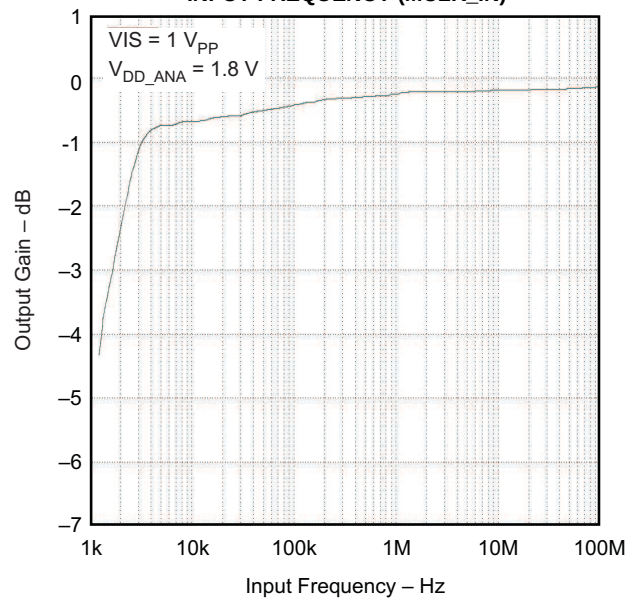


Figure 17.

## TYPICAL CHARACTERISTICS (continued)

INPUT  
vs  
OUTPUT PHASE-NOISE PERFORMANCE WITH 38.4-MHz TCXO

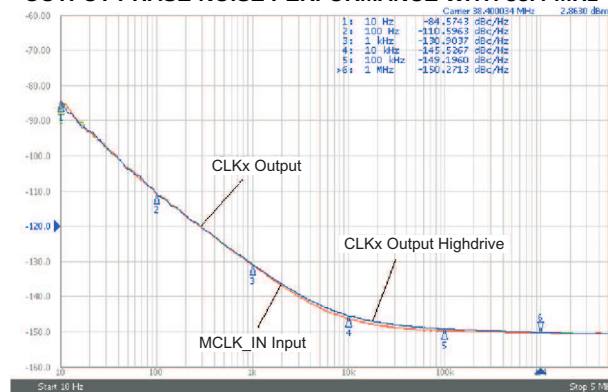


Figure 18.

INPUT  
vs  
OUTPUT PHASE-NOISE PERFORMANCE WITH 26-MHz TCXO

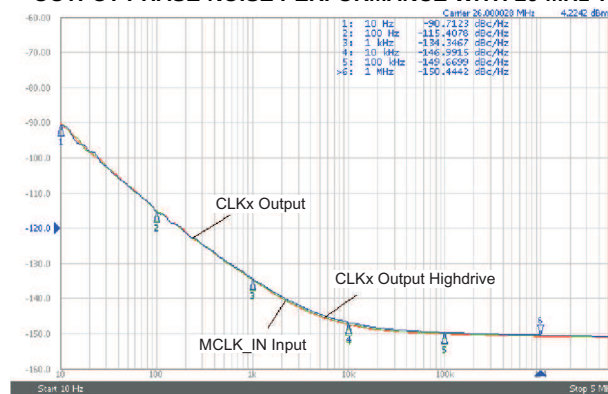


Figure 19.

LDO POWER SUPPLY REJECTION

vs  
FREQUENCY (PSRR)

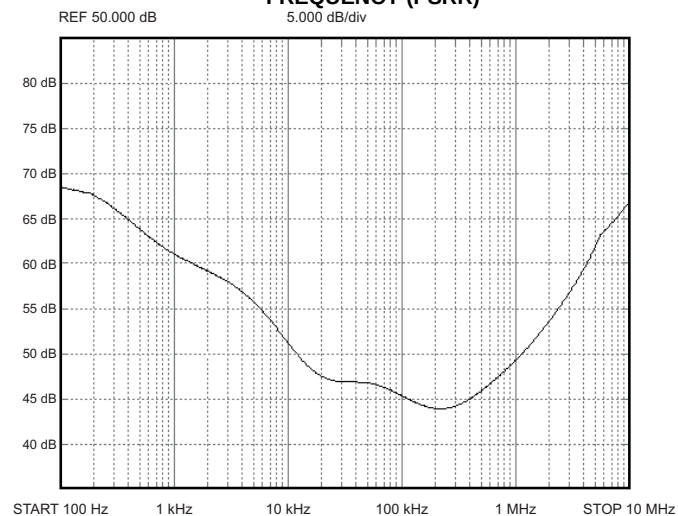
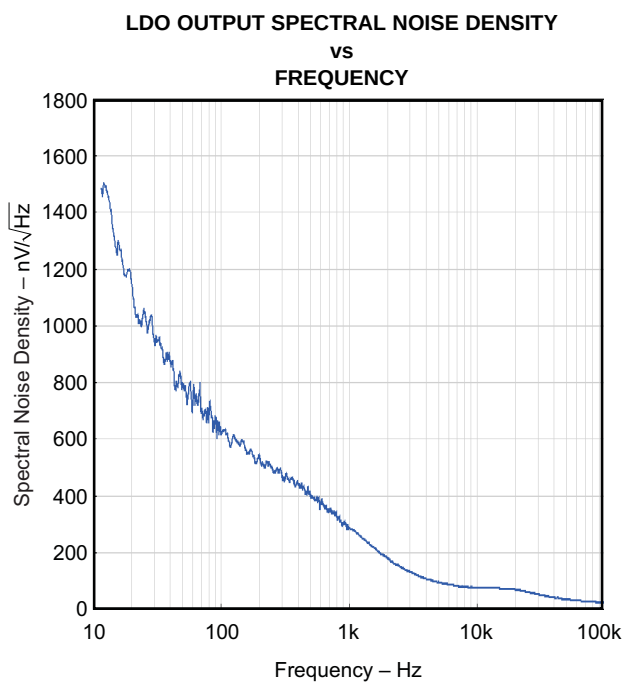


Figure 20.

## TYPICAL CHARACTERISTICS (continued)



**Figure 21.**

## DETAILED DESCRIPTION

### SDAH/SCLH SERIAL INTERFACE (Hs-Mode)

This section describes the SDAH/SCLH interface of the CDC3S04 device. The CDC3S04 operates as a slave device of the two-wire serial SDAH/SCLH bus, compatible with the popular I<sup>2</sup>C specification (UM10204-I<sup>2</sup>C-bus specification and user manual Rev. 03–19 June 2007). It operates in the high-speed mode (up to 3.4 Mbit/s) and supports 7-bit addressing. The CDC3S04 is fully downward compatible with fast- and standard-mode (F/S) devices for bidirectional communication in a mixed-speed bus system.

### Data Protocol

The device supports byte-write and byte-read operations only. There is no block-write or block-read operation supported; therefore, no command code byte is needed.

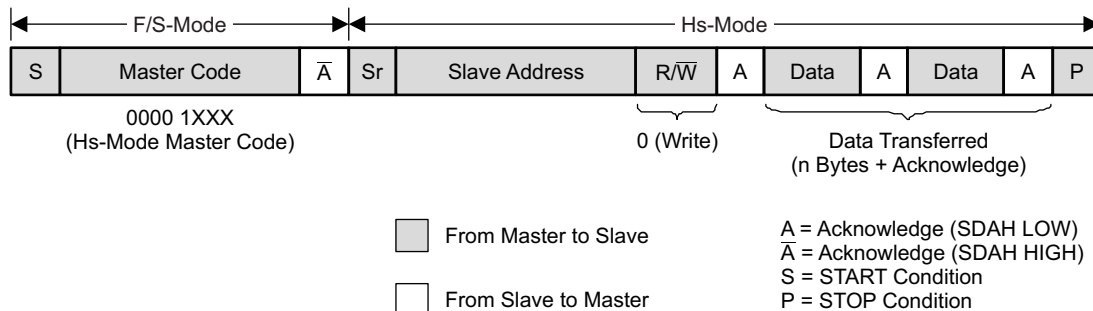
When a byte has been sent, it is written into the internal register and is immediately effective.

### Slave Receiver Address (7 bits)

| Device  | A6 | A5 | A4 | A3 | A2 | A1 | A0 <sup>(1)</sup> | R/ $\overline{W}$ |
|---------|----|----|----|----|----|----|-------------------|-------------------|
| CDC3S04 | 1  | 1  | 0  | 1  | 1  | 0  | 0                 | 1/0               |

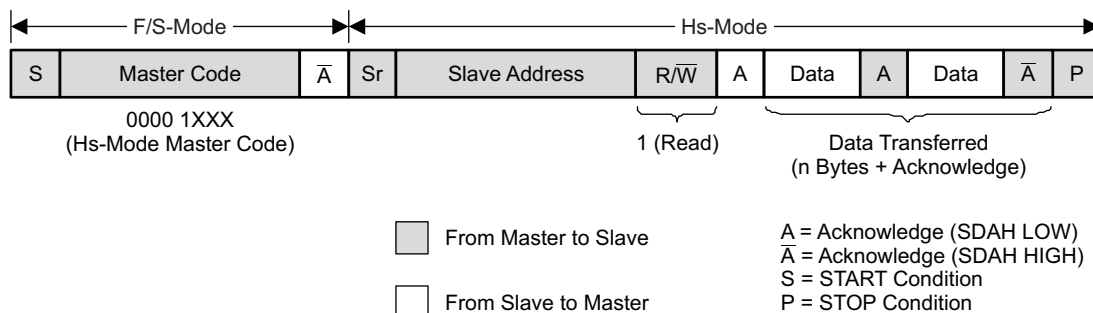
(1) Address bit A0 is selectable by the ADR\_A0 input (pin D1). This allows addressing of two devices connected to the same I<sup>2</sup>C bus. The default value is 0, set by an internal pulldown resistor.

### Byte-Write Programming Sequence

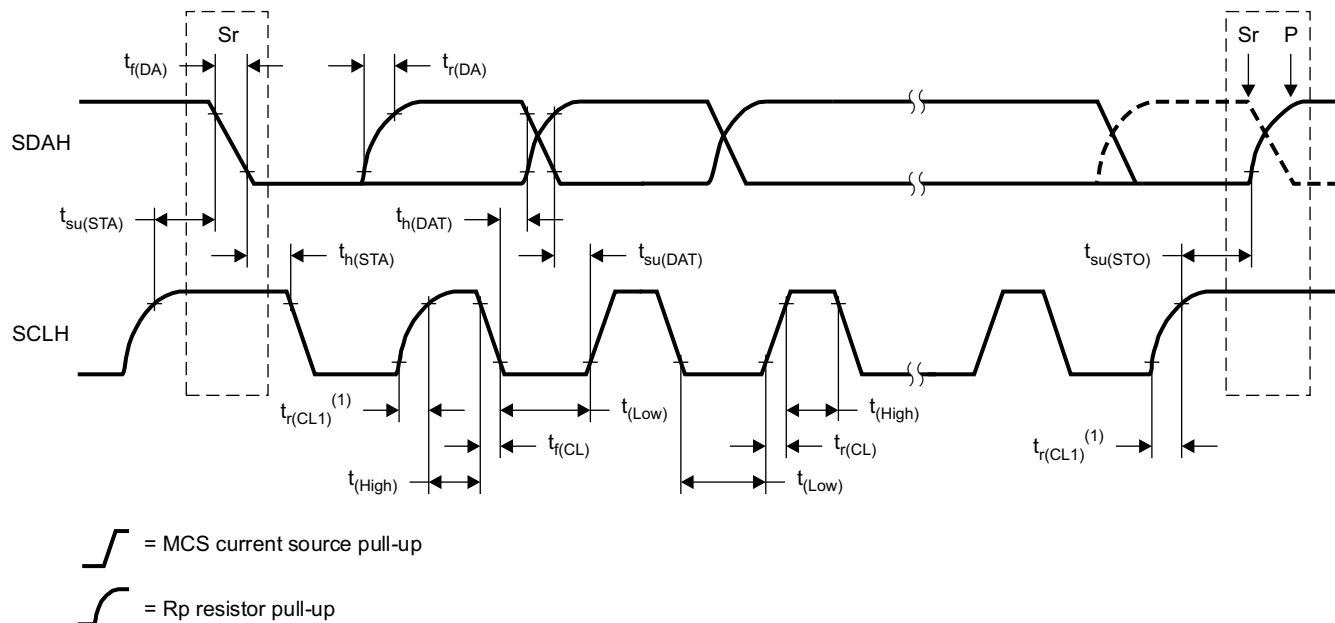


**Figure 22. Byte-Write Protocol**

### Byte-Read Programming Sequence



**Figure 23. Byte-Read Protocol**



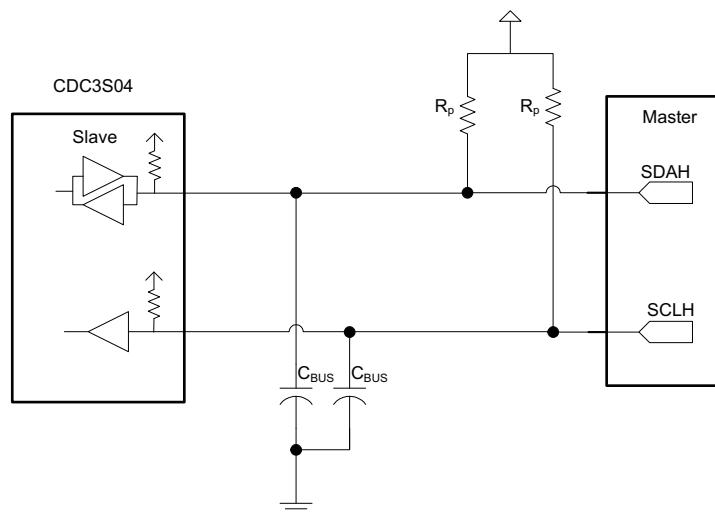
T0451-01

(1) First rising edge of the SCLH signal after  $Sr$  and after each acknowledge bit.

**Figure 24. Definition of Timing for a Complete Hs-Mode Transfer**

The following diagram shows how the CDC3S04 clock buffer is connected to the SDAH/SCLH serial interface bus. Multiple devices can be connected to the bus, but the speed may need to be reduced (3.4 MHz is the maximum) if many devices are connected.

Note that the pullup resistors ( $R_p$ ) depend on the supply voltage, bus capacitance, and number of connected devices. For more details, see the I<sup>2</sup>C bus specification.



**Figure 25. SDAH/SCLH Hardware Interface**

## SDAH/SCLH Configuration Registers

The output stages are user configurable. [Table 3](#) explains the programmable functions of the CDC3S04.

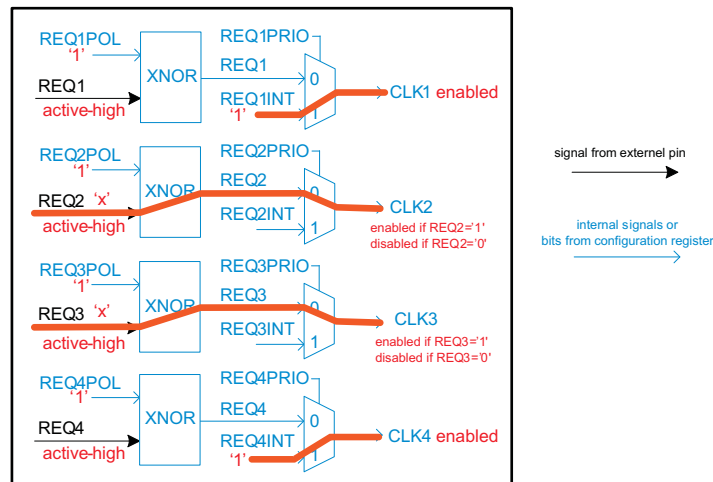
# CDC3S04

SCAS883C –OCTOBER 2009–REVISED AUGUST 2012

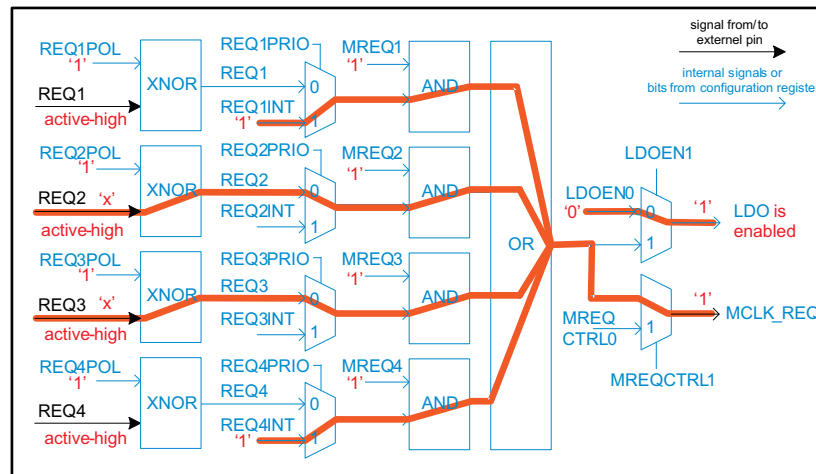
[www.ti.com](http://www.ti.com)
**Table 3. Configuration Register (Shaded Cells Marks Power-Up/Default Setting)**

| Offset                | BIT <sup>(1)</sup> | Acronym    | Default <sup>(2)</sup> | RESET <sup>(3)</sup> | Description                                                                                                                                | 0                     | 1                 | Type |
|-----------------------|--------------------|------------|------------------------|----------------------|--------------------------------------------------------------------------------------------------------------------------------------------|-----------------------|-------------------|------|
| 00h                   | 7                  | REQ4INT    | 1b                     | 1b                   | CLK4 off/on <sup>(4)</sup>                                                                                                                 | Off                   | On                | R/W  |
|                       | 6                  | REQ3INT    | 0b                     | –                    | CLK3 off/on <sup>(4)</sup>                                                                                                                 | Off                   | On                |      |
|                       | 5                  | REQ2INT    | 0b                     | –                    | CLK2 off/on <sup>(4)</sup>                                                                                                                 | Off                   | On                |      |
|                       | 4                  | REQ1INT    | 1b                     | 1b                   | CLK1 off/on <sup>(4)</sup>                                                                                                                 | Off                   | On                |      |
|                       | 3                  | REQ4POL    | 1b                     | –                    | Selects polarity of REQ4                                                                                                                   | Active-low            | Active-high       |      |
|                       | 2                  | REQ3POL    | 1b                     | –                    | Selects polarity of REQ3                                                                                                                   | Active-low            | Active-high       |      |
|                       | 1                  | REQ2POL    | 1b                     | –                    | Selects polarity of REQ2                                                                                                                   | Active-low            | Active-high       |      |
|                       | 0                  | REQ1POL    | 1b                     | –                    | Selects polarity of REQ1                                                                                                                   | Active-low            | Active-high       |      |
| 01h                   | 7                  | MREQ4      | 1b                     | –                    | Defines if REQ4 is used to decode MCLK_REQ                                                                                                 | Not used for decoding | Used for decoding | R/W  |
|                       | 6                  | MREQ3      | 1b                     | –                    | Defines if REQ3 is used to decode MCLK_REQ                                                                                                 |                       |                   |      |
|                       | 5                  | MREQ2      | 1b                     | –                    | Defines if REQ2 is used to decode MCLK_REQ                                                                                                 |                       |                   |      |
|                       | 4                  | MREQ1      | 1b                     | –                    | Defines if REQ1 is used to decode MCLK_REQ                                                                                                 |                       |                   |      |
|                       | 3                  | MCLKOUT1   | 00b                    | –                    | Selects MCLK_REQ output type<br>00 = wired-OR (default setting)<br>01 = wired-AND<br>1x = push-pull                                        |                       |                   |      |
|                       | 2                  | MCLKOUT0   |                        |                      |                                                                                                                                            |                       |                   |      |
|                       | 0–1                | –          | 00b                    | –                    | Reserved                                                                                                                                   |                       |                   |      |
| 02h                   | 7                  | MREQCTRL1  | 00b                    | –                    | MCLK_REQ generation (see <a href="#">Figure 27</a> )<br>0x = decoder controlled (default setting)<br>10 = low<br>11 = high                 |                       |                   | R/W  |
|                       | 6                  | MREQCTRL0  |                        |                      |                                                                                                                                            |                       |                   |      |
|                       | 5                  | LDOEN1     | 00b                    | –                    | Switches LDO on or off:<br>00 = LDO is on (default setting)<br>01 = LDO is off<br>1x = decoder controlled (see <a href="#">Figure 27</a> ) |                       |                   |      |
|                       | 4                  | LDOEN0     |                        |                      |                                                                                                                                            |                       |                   |      |
|                       | 3                  | REQ4PRIO   | 1b                     | 1b                   | Defines external vs internal REQ4 priority                                                                                                 | REQ4                  | REQ4INT           |      |
|                       | 2                  | REQ3PRIO   | 0b                     | –                    | Defines external vs internal REQ3 priority                                                                                                 | REQ3                  | REQ3INT           |      |
|                       | 1                  | REQ2PRIO   | 0b                     | –                    | Defines external vs internal REQ2 priority                                                                                                 | REQ2                  | REQ2INT           |      |
|                       | 0                  | REQ1PRIO   | 1b                     | 1b                   | Defines external vs internal REQ1 priority                                                                                                 | REQ1                  | REQ1INT           |      |
| 03h                   | 7                  | HIGHDRIVE4 | 0b                     | –                    | Enables high-drive capability CLK4                                                                                                         | Typical               | High              | R/W  |
|                       | 6                  | HIGHDRIVE3 | 0b                     | –                    | Enables high-drive capability CLK3                                                                                                         | Typical               | High              |      |
|                       | 5                  | HIGHDRIVE2 | 0b                     | –                    | Enables high-drive capability CLK2                                                                                                         | Typical               | High              |      |
|                       | 4                  | HIGHDRIVE1 | 0b                     | –                    | Enables high-drive capability CLK1                                                                                                         | Typical               | High              |      |
|                       | 0–3                | –          | 0b                     | –                    | Reserved                                                                                                                                   |                       |                   |      |
| 04h–Bh <sup>(5)</sup> |                    | –          |                        | –                    | Reserved                                                                                                                                   |                       |                   | R/W  |

- (1) All data is transferred with the MSB first.
- (2) A device reset to default condition is initiated by a  $V_{DD\_DIG}$  power-up sequence.
- (3) "–" means that dedicated bits do not change at RESET.
- (4) Inactive as long as the REQxPRIO bit is low, external REQx pins are valid (see [Figure 26](#))
- (5) Writing data beyond 03h may affect device function.

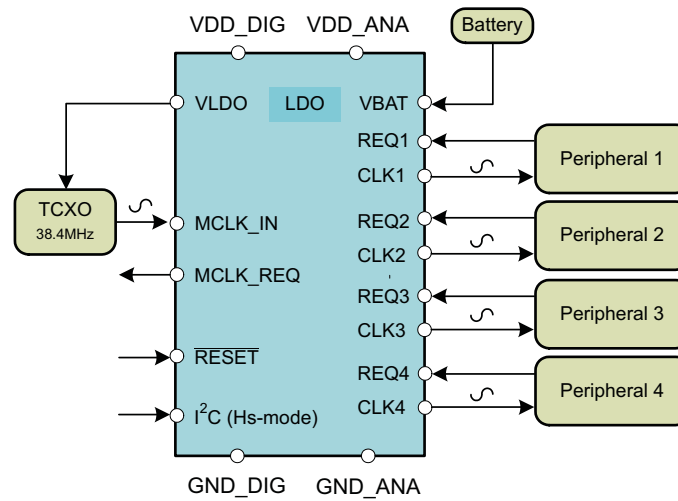


**Figure 26. Clock Output Enable Signal**  
(Shaded Line Marks Power-Up/Default Setting)



**Figure 27. Decoding Scheme for MCLK\_REQ and LDOEN**  
(Shaded Line Marks Power-Up/Default Setting)

## APPLICATION INFORMATION



**Figure 28. Clock Distribution Scheme**

## REVISION HISTORY

| Changes from Original (October 2009) to Revision A                                                                                                                                                                                                                                                                    | Page             |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------|
| <ul style="list-style-type: none"> <li>Changed the format on page 1 (moved 2 paragraphs from page 2 to page 1) .....</li> <li>Changed the X axis from 0.1us to 100us....900us .....</li> <li>Changed Offset 00h Bit 4 Default value from 0h to 1b .....</li> </ul>                                                    | 1<br>9<br>18     |
| Changes from Revision A (July 2010) to Revision B                                                                                                                                                                                                                                                                     | Page             |
| <ul style="list-style-type: none"> <li>Changed <a href="#">Table 3</a> "Offset" values listed in "Default" and "<math>\overline{\text{RESET}}</math>" columns from "h" to "b". .....</li> </ul>                                                                                                                       | 18               |
| Changes from Revision B (May 2011) to Revision C                                                                                                                                                                                                                                                                      | Page             |
| <ul style="list-style-type: none"> <li>Changed from Rev B, 2011 to Rev C, 2012 .....</li> <li>Changed the 8th Feature item from –30°C to –40°C .....</li> <li>Changed in the last paragraph of description from –30°C to –40°C .....</li> <li>Changed in the ROC table last row, from –30°C to –40°C .....</li> </ul> | 1<br>1<br>2<br>4 |

## PACKAGING INFORMATION

| Orderable part number       | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-----------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">CDC3S04YFFR</a> | Active        | Production           | DSBGA (YFF)   20 | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | CDC3S04             |
| CDC3S04YFFR.B               | Active        | Production           | DSBGA (YFF)   20 | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | CDC3S04             |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

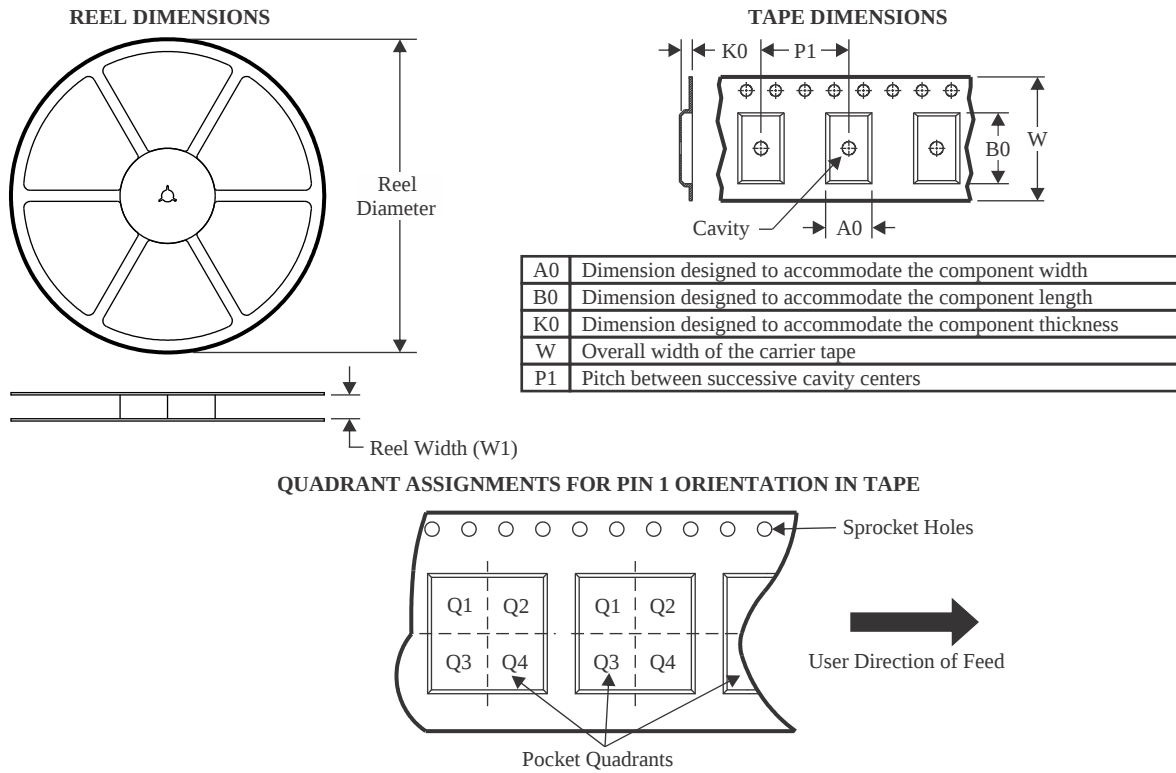
<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CDC3S04YFFR | DSBGA        | YFF             | 20   | 3000 | 180.0              | 8.4                | 1.63    | 2.08    | 0.69    | 4.0     | 8.0    | Q1            |

## TAPE AND REEL BOX DIMENSIONS

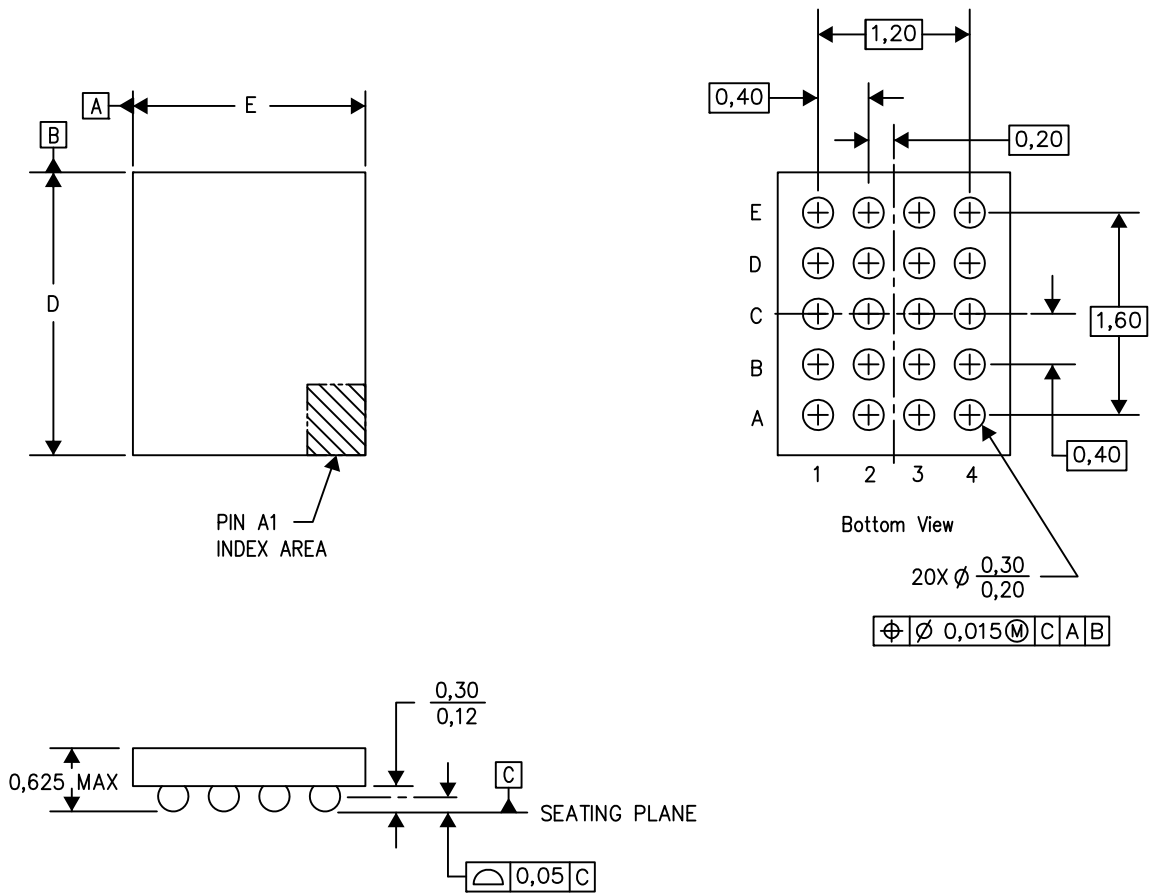


\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CDC3S04YFFR | DSBGA        | YFF             | 20   | 3000 | 182.0       | 182.0      | 20.0        |

YFF (R-XBGA-N20)

DIE-SIZE BALL GRID ARRAY



D: Max = 1.99 mm, Min = 1.93 mm

E: Max = 1.59 mm, Min = 1.53 mm

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- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. NanoFree™ package configuration.

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